

Application Data Sheet

Application Information

Application Type: Regular

Subject Matter: Utility

Suggested Classification:

Suggested Group Art Unit:

CD-ROM or CD-R?: None

Title: Semiconductor Structure with Integrated Shield

Request for Early Publication?: No

Request for Non-Publication?: No

Suggested Drawing Figure:

Total Drawing Sheets: 7

Small Entity: No

Petition included?: No

Secrecy Order in Parent Appl.?: No

Applicant Information

Applicant Authority type: Inventor

Primary Citizenship Country: Austria

Status: Full Capacity

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Representative Information

Representative Designation:	Registration Number:	Representative Name:
Primary	37,892	Harold C. Moore
Primary	34,984	Paul J. Maginot
Primary	32,722	Michael D. Beck
Primary	34,214	David M. Lockman
Primary	31,993	David B. Quick
Primary	35,458	Bruce J. Bowman

Foreign Priority Information

Country:	Application Number:	Filing Date:	Priority Claimed:
German	10257870.2	11 December 2002	Yes

Assignee Information

Assignee name: Infineon Technologies AG
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